



NOTES:

1. Material - .010" thickness, Lexan with matt lamination (.001")
2. Lettering & graphics to appear as per a/w file 1000406a.pdf (from Psion Teklogix).
3. Labels to be presented in 'fan fold' and packaged in boxes.
4. Rear surface to be FASSON 397 adhesive coated with release paper backing. Adhesive to be compatible with polycarbonate (Bayer Bayblend FR110) material over a temperature range of -40°C to +125°C.

ITEM GROUP	D00LBL	APPROVALS	DATE	PSION TEKLOGIX Mississauga, Ontario Canada
PRODUCT TYPE	HH0	DRAWN V.Vukovic	02.04.18	
EDR/EDO STATUS		CHKD V.V. APPVD		LABEL RFID REAR CE/FCC
EXPIRED/DISCONTINUED				
ENGINEERING ONLY				
PRE-PILOT		PROD. ENG. /PROJ. ENG. <i>shl</i>	02.04.19	
BETA				
X RELEASED		MECH. ENG.		Dwg No. 1000406
EDR/EDO NO.:		REGULATORY		REV. A
REL. DATE:				Sheet 1 of 1